

Coilmaster



SPECIFICATION APPROVAL

CUSTOMER :	Ozdisan
PRODUCT :	SQH4018-1R0N-LF

Pb-free

CODE NO. : C03040194

CUS. CODE :

SPEC.NO. : C-3040-194(00)

DATE : 8-Apr-25

CUSTOMER APPROVAL

Coilmaster Electronics Co., Ltd.

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PREPARED BY	APPROVED BY	AUTHORIZED BY	
JEAN	ΤΟΝΥ	MASCOT	

PRODUCT	SQH4018-1R0N-LF	COIL		DATE	2025/4/8
SPEC.NO.	C-3040-194(00)	SPECIFICAT	TION	CODE NO.	C03040194
	XXX B				4.2 Max. m/m
, i i i i i i i i i i i i i i i i i i i	\mathbf{X}				4.2 Max. m/m
ELECTRICAL				D .	1.8 Max. m/m
L(µH	H) :	1.0±30% 100KHz	z 1V		
	$R(m\Omega)$:	28 Max.			
Isat($X \ge 0Ax70\%$)	
	UCTANCE DROP :	30% Typ. @ IDC	10.0	A	
Irms		6.00 Max.			
Oper	rating Temperature Range	$: -40^{\circ}C \sim +125^{\circ}C$			
SCHEMATIC	DRAWING :	PCB P	ATTERN :	:	
S F " • " start fi	ϕ Ts(Ref.)	T		I G	G: 1.20 m/m H: 3.70 m/m I: 1.60 m/m
MATERIAL LI	IST :				
NO I	ГЕМ М.	ATERIAL	SU	PPLIER OF THE MA	ATERIAL
1					
2					
3					
4					

R	0.00	0.00	0.00			
				DIMENSION		
MEAS. ITEM	А	В	С	D		
TEST FREQ.	m/m	m/m	m/m	m/m		
YOUR						
SPEC.	4.2 Max.	4.2 Max.		1.8 Max.		
1						
2						
3						
4						
5						
6						
7						
8						
9						
10						
Х	#DIV/0!	#DIV/0!		#DIV/0!		
R	0.00	0.00		0.00		

			ELECTRIC	AL CHARAC	TERISTICS		
MEAS. ITEM	L(µH)	DCR(mΩ)	Isat(A)				
TEST FREQ.	100KHz 1V	Max.					
YOUR			L(4.00A)				
SPEC.	1.0±30%	28.0	\geq 0Ax70%				
1							
2							
3							
4							
5							
6							
7							
8							
9							
10							
Х	#DIV/0!	#DIV/0!	#DIV/0!				
R	0.00	0.00	0.00				

PRODUCT	SQH4018-1R0N-LF	COIL	DATE	2025/4/8
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TEST DATA

PRODUCT	SQH4018	3-1RON-LF	COIL		DATE	2025/4/8		
SPEC.NO.	C-3040	-194(00)	SPECIFICA	TION	CODE NO.	C03040194		
TEST ITI	EMS	SPE	CIFICATIONS	TEST	CONDITIONS /	TEST METHODS		
ELECTRICAL P	ERFORMA	NCE TEST						
L				CH-1061 OR	EQUIV.			
DCR		-		CH-502A OR EQUIV				
RATED CURRENT		REFER TO S CHARACTE	CHARACTERISTIC LIST.		APPLIED THE CURRENT TO COILS THE IDUCTANCE CHANGE SHOULD BE LESS THAN 30% TO INITIAL VALUE AND TEMPERATURE RISE SHOULD NOT BE MORE THAN 40°C			
				1. APPLIED 7	THE ALLOWED DC	CURRENT FOR 4 HOURS.		
TEMPERATURERIS	SE TEST	40°C MAX (2	∆t)	2. TEMPERATURE MEASURE BY DIGTAL SURFACE				
				THERMON		ALLOWED DC CURRENT		
OVER LOAD TEST		NO EVIDEN DAMAGE	CE OF ELECTRICAL		TIMES OF RATED			
MECHANICAL I	PERFORM.	ANCE TEST	n					
				PREHEAT:15	0℃ 60SECS			
SOLDER HEAT RES	SISTANCE					eheating Dipping Natural cooling		
VIBRATION TEST (LOW FREQUENCY)		EVIDENCE (RS SHOULD HAVE NO OF ELEC- TRICAL AND	255±5℃ FLUX: ROXI	N 150°C	60 10±0.5 econd second		
		MICHANICA	2. INDUCTANCE THANGE MORE THAN±	DIP TIME:10				
		10% SOLDER MA	3. ATERIAL WILL BE LEAD	1.AMPLITUE	DE: 1.5 mm			
		FREE.		2.FREQUENCY: 10-55-10HZ / 1 MIN				
				3.DIRECTION: X, Y, Z				
				4.DURATION	I: 2 HRS/X, Y, Z			
SHOCK TEST					SHOULD BE DROF Im ONTO 3cm WOO	PPED 10 TIMES FROM A DDEN BOARD.		

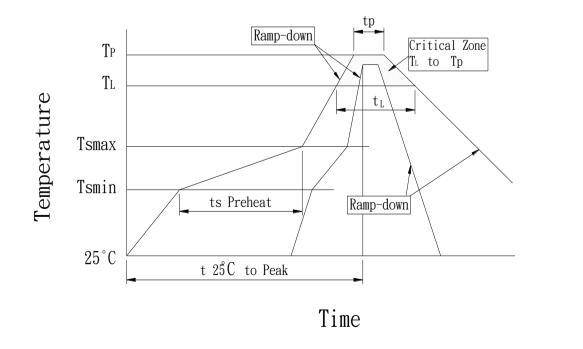
PRODUCT	SQH4018-1R0N-LF		COIL	DATE	2025/4/8
SPEC.NO.	C-3040-194(00)	SPEC	CIFICATION	CODE NO.	C03040194
TEST ITEMS	S SPECIFICA	TIONS	TEST CON	DITIONS / TEST	METHODS
MECHANICAL PI	ERFORMANCE TEST	<u></u>			
SOLDERABILITY TE	MORE THAN 90% (TERMINAL ELECT SHOULD BE COVE SOLDER.	RODE	AFTER FLUXING, INDUC BE DIPPEDIN A MELTED BATH AT 255±5°C FOR 5 \$	SOLDER	Preheating Dipping Natural cooling 60 second 4 ±0.5 second
COMPONENT ADHESION (PUSH TEST)	1.5Kg Min		THE DEVICE SHOULD BI SOLDERED (255±5°C FOF SECONDS) TO A TINNED SUBSTRATE. A DYNOME GAUGE SHOULD BE APP THE SIDE OF THE COMPO DEVICE MUST WITH- STA MINIMUM FORCE OF 1.51 WITHOUT AILURE OF TH TERMINATION . ATTACH COMPONENT.	R 10 COPPER TER FORCE LIED TO DNENT. THE AND A Kg E	
COMPONENT ADHESION (PULL TEST)	1.5Kg Min		1.INSERT 10cm WIRE INT REMAINING OPEN EYE B ENDS OF EVEN WIRE LEI UPWARD AND WIND TOO 2. TERM SHALL NOT BEREMARKA DAMAGED	EEND THE NGTHS GETHER MINAL	
FLEXTURE STRENG	THE FORCES APPL TH SHOULD NOT DAN DIELECTRIC.		SOLDER A CHIP ON A TE SUBSTRATE, BEND THE S BY 2mm AND RETURN.		45nn 45nn 100nn
RESISTANCE TO SOLVENT TEST	THERE SHOULD B CASEDEFORMATI CHANGE IN APPE BITERATION OF M	ON, ARANCE OR	INDUCTERS SHALL WITH	ISTAND 6 MINTES	OF ALCOHOL

SPEC.NO.			18-1RON-LF COIL DATE 2			2025/4/8	
SPEC.NO.	C- .	3040-194(00)	SPECIFI	CATION	CODE NO.	C03040194	
TEST ITEM;	S	SPECIFIC	CATIONS	TEST CO	ONDITIONS / TE	ST METHODS	
<u>CLIMATIC TEST</u>	-			•			
TEMPERATURE CHARACTERISTIC				- 40°C ~ +125°C			
HUMIDITY TEST				60°C ±2°C / 96±2 HOURS			
LOW TEMPERATURE		1.APPEARANCE:NO DAMAGE 2.INDUCTANCE:WITHIN±10% OF INITIAL VALUE.		1.TEMPERATURE:- 25°C ±2°C 2.TIME: 96±2 HOURS			
THERMAL SHOCK TEST				125±5°C FOR 30 MINUTES. +85°C -1000000000000000000000000000000000000			
HIGH TEMPERATUI STORAGE	RE			1.APPLIED CURRENT: MAX RATED CURRENT 2.TEMPERATURE:80℃±2℃			
NOTE : INDUCTOR	S ARE	TO BE TESTED AF	TER 2 HOUR AT RO	I DOM TEMPERATURI	3.		
<u>LIFE TEST</u>							
HIGH TEMPERATURE LOAD LIFE TEST		INDUCTORS SHOULD BE NO		1. TEMPERATURE: 80±2°C 2. TIME: 500±12 HOURS 3. LOAD: ALLOWED DC CURREN			
HUMIDITY LOAD L TEST	1	EVIDENCE OF SHORT OR OPEN CIRCUIT		1. TEMPERATURE: 60±2°C 2. R.H.: 90-95% 3. TIME: 500±12 HOURS 4. LOAD: ALLOWED DC CURREN			

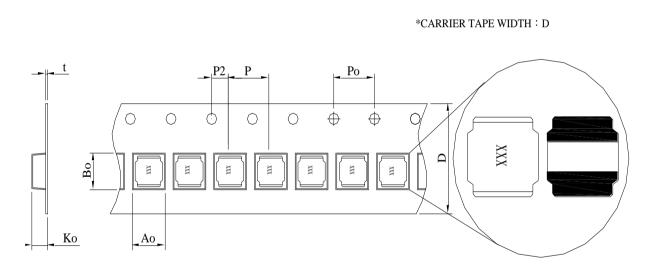
PRODUCT	SQH4018-1R0N-LF	CC	DIL	DATE	2025/4/8	
SPEC.NO.	C-3040-194(00)		ICATION	CODE NO.	C03040194	
RECOMMEND	DED SOLDERING CO					
LASSIFICATIO	N REFLOW PROFILES					
SOH40	018-1R0N-LF					
	Drafila Calatura	Sn-Pb Euteo	tic Assembly	Pb-Free Assembly		
'	Profile Feature	Large Body	Small Body	Large Body	Small Body	
Average ram (T _L to T _P)	ıp-up rate	3℃/seco	ond max.	3℃/second max.		
	e Min (Ts _{min}) e Min (Ts _{max}) o max) (ts)	100℃ 150℃ 60-120 seconds		150℃ 200℃ 60-180 seconds		
Tsmax to T _L -Ramp-up R				3℃/seco	ond max.	
Time mainta -Temperatur -Time (t _L)			3°C seconds	217℃ 60-150 seconds		
Peak Tempe	erature (Tp)	225 +0/-5℃	240 +0/-5℃	245 +0/-5℃	255 +5/-5℃	
Time within Temperature	5℃ of actual Peak e (tp)	10-30 seconds	10-30 seconds	10-30 seconds	20-40 seconds	
Ramp-down	Rate	6℃/seco	ond max.	6℃/seco	ond max.	
Time 25℃ to	Peak Temperature	6 minut	es max.	8 minute	es max.	

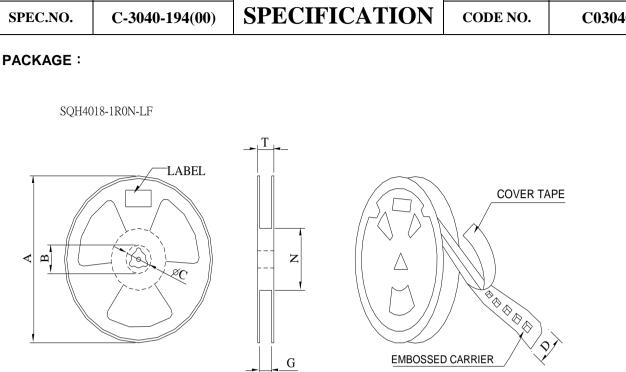
Note : All temperatures refer t topside of the package. Measured on the package body surface.

REFLOW SLODERINGS



STYLE						DIM	IENSIC	ONS (n	n/m)						
STILE	Q'TY (PCS)	А	В	С	D	G	Ν	Т	Ao	Во	Ko	t	Ρ	Po	P2
330	3000	330		2.0 ±0.5	12 ±0.2	12 ±0.5	75 ±0.2	_	4.3 ±0.1	4.3 ±0.1	2.2 ±0.1	0.35 ±0.05	8	4	2





COIL

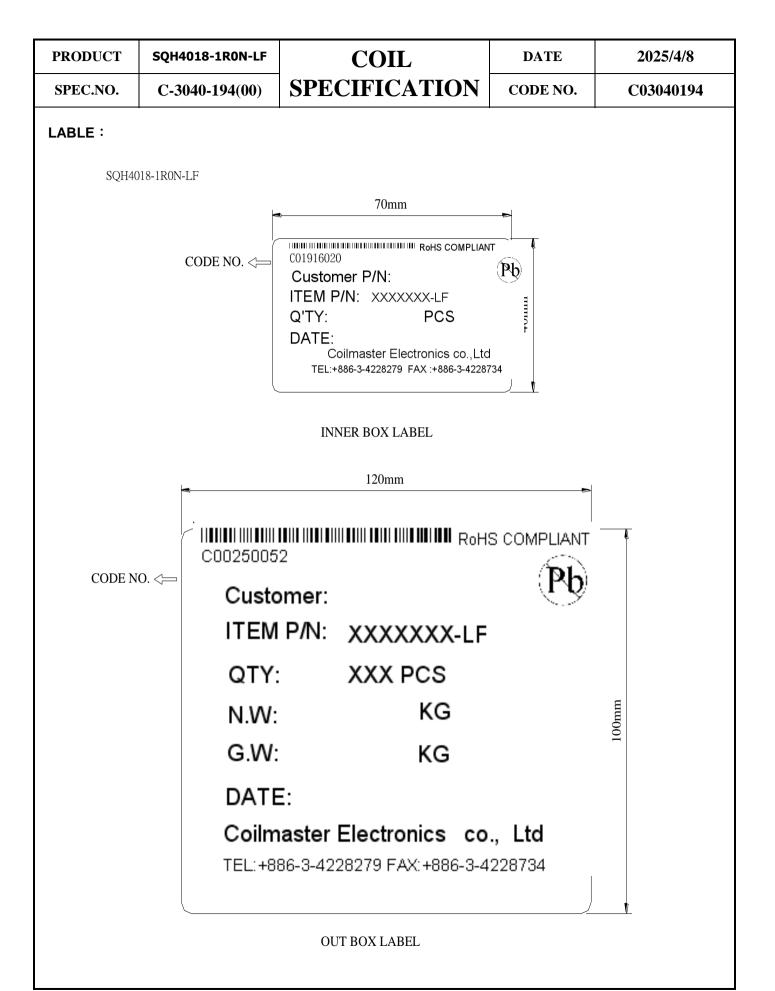
PRODUCT

SQH4018-1R0N-LF

DATE

C03040194

2025/4/8



PRODUCT	SQH4018-1RON-LF	COIL	DATE	2025/4/8
SPEC.NO.	C-3040-194(00)	SPECIFICATION	CODE NO.	C03040194
Void appeara	nce tolerance Limit:			
ize of voids occu	urring to coating resin is s	specified below.		
SQH	4018-1R0N-LF			
Exposed wi	ra talaranga limit for tha	coating resin part on the product side	a is specified as follow	W0.
-		ating resin is specified below.	e is specified as folio	w5.
-	-	imension b is unspecified.		
-	rection (dimension b): A	-		
		to each sides is not greater than 50% of co	ating main area and is	agantahla
5. The total al	ea of exposed whe occurring	to each sides is not greater than 50% of co	Jating resin area, and is a	icceptable.
Core chipping				
	ance standard of the chin	ping size on top side, and bottom sid	e ferrite core is listed	below
		g and manufacturing process.		
-	ceptance limits subjected			
-	Defect limit is based on	-		
		roduct function, see the IPC standard	1 & 2.	
20me omp				
For the proc	luct dimension for SQH2	20 /SQH25 series L: ≤ 50 %	of the length / W:	≤ 25 % of the width
For the proc	luct dimension for SQH3	30 /SQH40 series L: 0.7mm	Max / W: 0.7mm M	ax
For the proc	luct dimension for SQH	50/ SQH60 / SQH80 serie L: 1.0mm	Max / W: 1.0mm M	ax
Defects type	cally occur at the corner	s and edges of the product.		
These may	manifest as slight blacker	ning and roughness		
-		ing und roughness,		

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Cautions and Warnings :				
1. All of the comr SQH4018-1R0N-LF medical, military and aerospace except for general electronic devices, Coilmaster must be asked for written approval before incorporating the components into these areas.				
2. The components that will be used in high-reliability / high level of safety applications should be pre-evaluated by the end customer. Especially in customer applications in which the malfunction or failure of an electronic component could endanger human life or health. The customer shall be responsible for evaluating and confirming Coilmaster product is suitable for use in customer's applications.				
3. Customer must be cautioned to verify that data sheets are the updated ones before placing orders. In the individual cases, any trouble or failure of electronic components happens during their long span cannot be eliminated even follow the instruction with existing technology.				
 Washing / Cleaning process may jeopardize the product and cause the defect. Washing agents may harm the long-term functionality of the product The storage period should not be longer than 12 months (In the specific storage environment). The oxidization may happen on the terminals. Hence all the products shall be used within 12 months after the shipping date. If the time is over 12 months, please check the solderability before use it. 				
6. Products should not be kept in unsuitable storage conditions, such as areas susceptible to high humidity, high temperatures, dust or corrosion.				
7. Don't touch electrodes directly with bare hands as oil secretions may inhibit soldering. Always ensure optimum conditions for soldering.				
8. Don't bend the terminals or subject them to excessive stress.				
 Please ensure that all terminals and case lugs are completely fixed with solder onto PCB Ensure the tuning slug or cap is not fixed by solder flux during the production process. 				
11. Avoid placing coils near the edge of the PCB				
12. Don't touch any exposed winding part and avoid coming into contact with the guide of the electrode in automatic mounting				
13. The inductor / coil / common mode choke generates heat when current is applied. Please take care of this during the design.				
14. Always handle the product with care to prevent the damage.				
15. Our specification specifies the quality of the component as a single unit. Please ensure the component is thoroughly evaluated in your application circuit. Even for customized products, conclusive validation of the component in the circuit can only be carried out by customer.				
16. The general testing condition is in the room temperature 25 +/- 5°C and humidity under 65% RH, which is applied to all products.				
17. If have any query, please feel free to contact our sales department.				